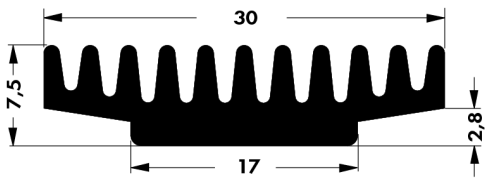
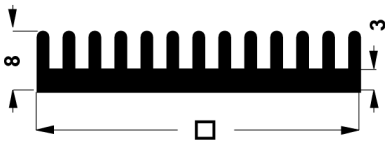


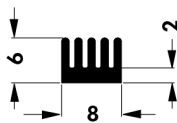
Heatsinks for SMD



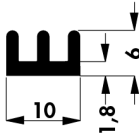
art. no.	R_{th} [K/W]	$\varnothing$ [mm]
ICK SMD C 7 ...	33	7
ICK SMD C 10 ...	26	10
ICK SMD C 17 ...	17	17



art. no.	R_{th} [K/W]	$\varnothing$ [mm]
ICK SMD E 15 ...	27	15.3
ICK SMD E 22 ...	21	22.3
ICK SMD E 29 ...	18	29.0



art. no.	R_{th} [K/W]	$\varnothing$ [mm]
ICK SMD F 8 ...	74	8
ICK SMD F 10 ...	71	10
ICK SMD F 17 ...	42	17
ICK SMD F 19 ...	37	19
ICK SMD F 21 ...	33	21
ICK SMD F 26 ...	26	26



art. no.	R_{th} [K/W]	$\varnothing$ [mm]
ICK SMD G 8 ...	73	8
ICK SMD G 10 ...	70	10
ICK SMD G 13 ...	61	13
ICK SMD G 17 ...	41	17
ICK SMD G 19 ...	36	19
ICK SMD G 21 ...	32	21

please indicate: ... surface treatment
SA=black anodised
MI=solderable surface

Thermal conduct. foil WLFT 404/405 → E 5
Thermal conductive glue → E 14
Thermal conductive paste → E 12
Silicone wafers → E 2 – 4

Profiles for PCB mounting
U-shaped heatsink
Heatsinks for PCB
Pin heatsinks for IC

→ A 87 – 108
→ A 117 – 120
→ A 87 – 89
→ B 16 – 22